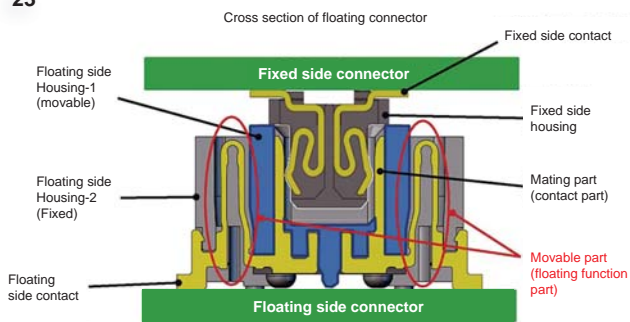


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* Tightening with screw between boards is recommended for ensuring absorption of vibration and shock.

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